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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	128
Number of Logic Elements/Cells	-
Total RAM Bits	147456
Number of I/O	92
Number of Gates	80000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-TFBGA, CSPBGA
Supplier Device Package	144-LCSBGA (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v80-6csg144c

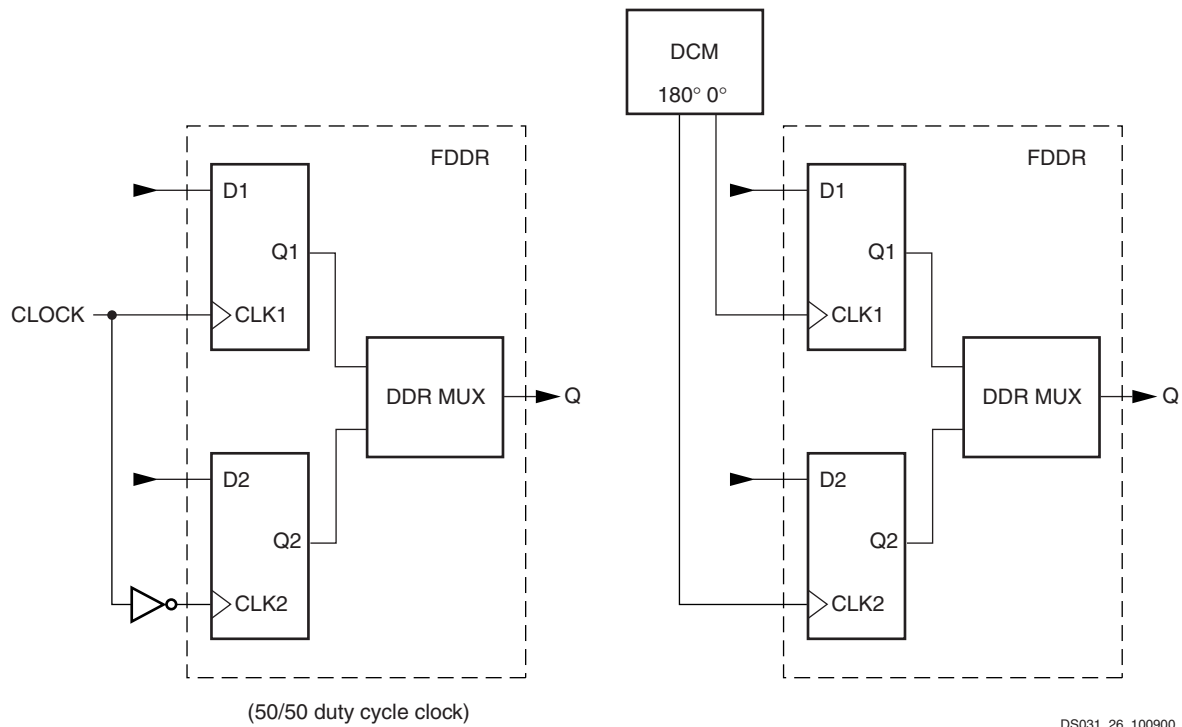


Figure 3: Double Data Rate Registers

The DDR mechanism shown in Figure 3 can be used to mirror a copy of the clock on the output. This is useful for propagating a clock along the data that has an identical delay. It is also useful for multiple clock generation, where there is a unique clock driver for every clock load. Virtex-II devices can produce many copies of a clock with very little skew.

Each group of two registers has a clock enable signal (ICE for the input registers, OCE for the output registers, and TCE for the 3-state registers). The clock enable signals are active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

Each IOB block has common synchronous or asynchronous set and reset (SR and REV signals).

SR forces the storage element into the state specified by the SRHIGH or SRLOW attribute. SRHIGH forces a logic "1". SRLOW forces a logic "0". When SR is used, a second input (REV) forces the storage element into the opposite state. The reset condition predominates over the set condition. The initial state after configuration or global initialization state is defined by a separate INIT0 and INIT1 attribute. By default, the SRLOW attribute forces INIT0, and the SRHIGH attribute forces INIT1.

For each storage element, the SRHIGH, SRLOW, INIT0, and INIT1 attributes are independent. Synchronous or asynchronous set / reset is consistent in an IOB block.

All the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Each register or latch (independent of all other registers or latches) (see Figure 4) can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset overrides a set, and an asynchronous clear overrides a preset.

Multiplexers

Virtex-II function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in **Figure 23**. Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

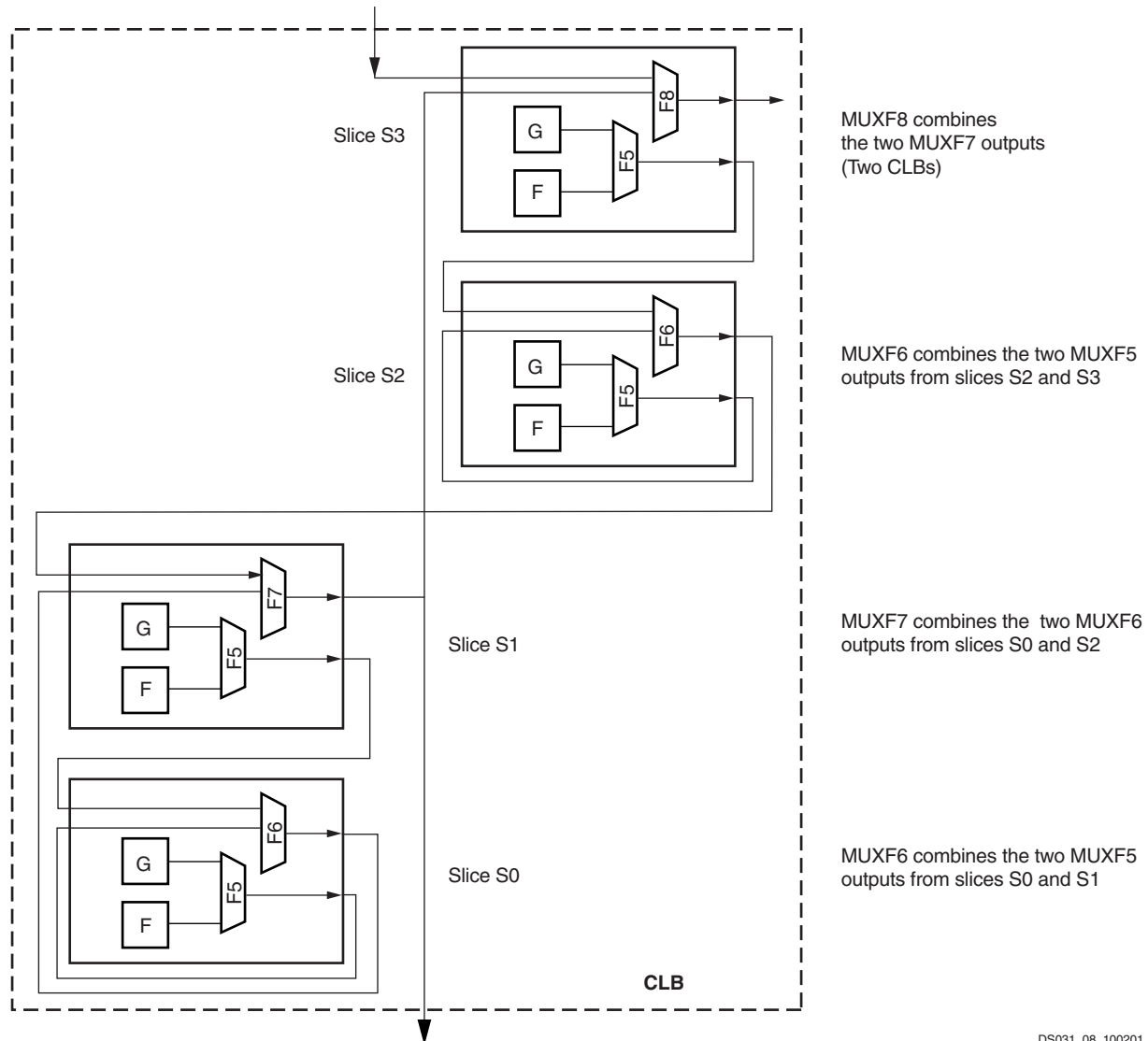


Figure 23: MUXF5 and MUXFX multiplexers

DS031_08_100201

Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II CLB has two separate carry chains, as shown in the **Figure 24**.

The height of the carry chains is two bits per slice. The carry chain in the Virtex-II device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also

be used to cascade function generators for implementing wide logic functions.

Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in **Figure 16**) improves the efficiency of multiplier implementation.

Each SelectRAM memory and multiplier block is tied to four switch matrices, as shown in [Figure 35](#).

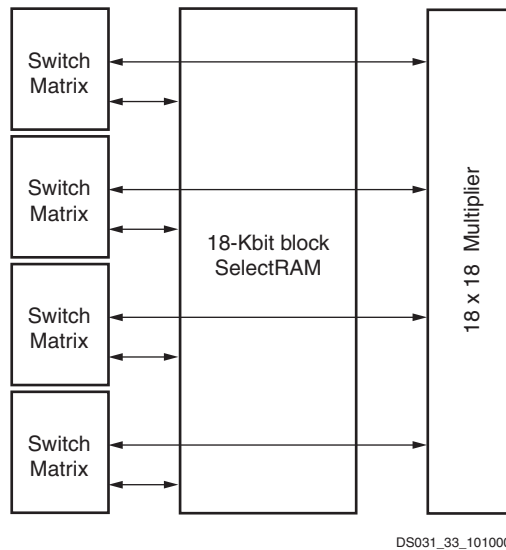


Figure 35: SelectRAM and Multiplier Blocks

Association With Block SelectRAM Memory

The interconnect is designed to allow SelectRAM memory and multiplier blocks to be used at the same time, but some interconnect is shared between the SelectRAM and the multiplier. Thus, SelectRAM memory can be used only up to 18 bits wide when the multiplier is used, because the multiplier shares inputs with the upper data bits of the SelectRAM memory.

This sharing of the interconnect is optimized for an 18-bit-wide block SelectRAM resource feeding the multiplier. The use of SelectRAM memory and the multiplier with an accumulator in LUTs allows for implementation of a digital signal processor (DSP) multiplier-accumulator (MAC) function, which is commonly used in finite and infinite impulse response (FIR and IIR) digital filters.

Configuration

The multiplier block is an 18-bit by 18-bit signed multiplier (2's complement). Both A and B are 18-bit-wide inputs, and the output is 36 bits. [Figure 36](#) shows a multiplier block.

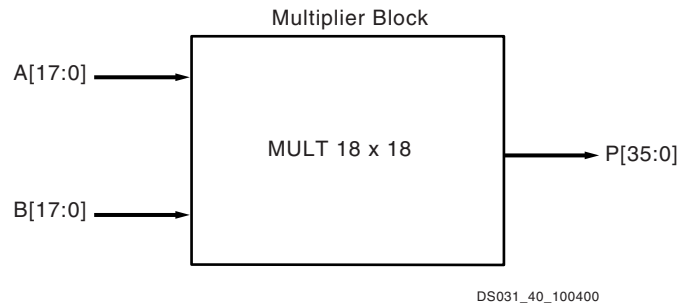


Figure 36: Multiplier Block

Locations / Organization

Multiplier organization is identical to the 18 Kbit SelectRAM organization, because each multiplier is associated with an 18 Kbit block SelectRAM resource.

In addition to the built-in multiplier blocks, the CLB elements have dedicated logic to implement efficient multipliers in logic. (Refer to [Configurable Logic Blocks \(CLBs\)](#)).

Table 20: Multiplier Floor Plan

Device	Columns	Multipliers	
		Per Column	Total
XC2V40	2	2	4
XC2V80	2	4	8
XC2V250	4	6	24
XC2V500	4	8	32
XC2V1000	4	10	40
XC2V1500	4	12	48
XC2V2000	4	14	56
XC2V3000	6	16	96
XC2V4000	6	20	120
XC2V6000	6	24	144
XC2V8000	6	28	168

I/O Standard Adjustment Measurement Methodology

Input Delay Measurements

Table 18 shows the test setup parameters used for measuring Input standard adjustments (see Table 15, page 11).

Table 18: Input Delay Measurement Methodology

Description	IOSTANDARD Attribute	$V_L^{(1,2)}$	$V_H^{(1,2)}$	$V_{MEAS}^{(1,4,5)}$	$V_{REF}^{(1,3,5)}$
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL	0	3.0	1.4	–
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	0	3.3	1.65	–
LVC MOS, 2.5V	LVC MOS25	0	2.5	1.25	–
LVC MOS, 1.8V	LVC MOS18	0	1.8	0.9	–
LVC MOS, 1.5V	LVC MOS15	0	1.5	0.75	–
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	Per PCI Specification			–
PCI, 66 MHz, 3.3V	PCI66_3	Per PCI Specification			–
PCI-X, 133 MHz, 3.3V	PCIX	Per PCI-X Specification			–
GTL (Gunning Transceiver Logic)	GTL	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	0.80
GTL Plus	GTL P	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	1.0
HSTL (High-Speed Transceiver Logic), Class I & II	HSTL_I, HSTL_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.75
HSTL, Class III & IV	HSTL_III, HSTL_IV	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class I & II, 1.8V	HSTL_I_18, HSTL_II_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class III & IV, 1.8V	HSTL_III_18, HSTL_IV_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	1.08
SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V	SSTL3_I, SSTL3_II	$V_{REF} - 1.00$	$V_{REF} + 1.00$	V_{REF}	1.5
SSTL, Class I & II, 2.5V	SSTL2_I, SSTL2_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.25
SSTL, Class I & II, 1.8V	SSTL18_I, SSTL18_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
AGP-2X/AGP (Accelerated Graphics Port)	AGP	$V_{REF} - (0.2 \times V_{CCO})$	$V_{REF} + (0.2 \times V_{CCO})$	V_{REF}	AGP Spec
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDS, 3.3V	LVDS_33	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDSEXT, 3.3V	LVDSEXT_33	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	$0.6 - 0.125$	$0.6 + 0.125$	0.6	
LDT (HyperTransport), 2.5V	LDT_25	$0.6 - 0.125$	$0.6 + 0.125$	0.6	
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$1.6 - 0.3$	$1.6 + 0.3$	1.6	

Notes:

1. Input delay measurement methodology parameters for LVDCI and HSLVDCI are the same as for LVC MOS standards of the same voltage. Parameters for all other DCI standards are the same as for the corresponding non-DCI standards.
2. Input waveform switches between V_L and V_H .
3. Measurements are made at typical, minimum, and maximum V_{REF} values. Reported delays reflect worst case of these measurements. V_{REF} values listed are typical. See [Virtex-II Platform FPGA User Guide](#) for min/max specifications.
4. Input voltage level from which measurement starts.
5. Note that this is an input voltage reference that bears no relation to the V_{REF} / V_{MEAS} parameters found in IBIS models and/or noted in Figure 1.

Global Clock Setup and Hold for LVTTL Standard, *Without DCM*

Table 37: Global Clock Setup and Hold for LVTTL Standard, *Without DCM*

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Input Setup and Hold Time Relative to Global Clock Input Signal for LVTTL Standard. ⁽²⁾ For data input with different standards, adjust the setup time delay by the values shown in IOB Input Switching Characteristics Standard Adjustments, page 11 .						
Full Delay Global Clock and IFF ⁽¹⁾ without DCM	T _{PSFD} /T _{PHFD}	XC2V40	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V80	2.10/ 0.00	2.10/ 0.00	2.21/ 0.00	ns
		XC2V250	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V500	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V1000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V1500	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V2000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V3000	1.92/ 0.00	1.92/ 0.00	2.21/ 0.00	ns
		XC2V4000	2.00/ 0.00	2.00/ 0.00	2.30/ 0.00	ns
		XC2V6000	1.92/ 0.50	1.92/ 0.50	2.21/ 0.50	ns
		XC2V8000		2.38/ 0.00	2.60/ 0.00	ns

Notes:

1. IFF = Input Flip-Flop or Latch
2. Setup time is measured relative to the Global Clock input signal with the fastest route and the lightest load. Hold time is measured relative to the Global Clock input signal with the slowest route and heaviest load.
3. These values are parametrically measured.

Input Clock Tolerances

Table 39: Input Clock Tolerances

Description	Symbol	Constraints F _{CLKIN}	Speed Grade						Units
			-6		-5		-4		
			Min	Max	Min	Max	Min	Max	
Input Clock Low/High Pulse Width									
PSCLK	PSCLK_PULSE	< 1MHz	25.00		25.00		25.00		ns
PSCLK and CLKIN ⁽³⁾	PSCLK_PULSE and CLKIN_PULSE	1 – 10 MHz	25.00		25.00		25.00		ns
		10 – 25 MHz	10.00		10.00		10.00		ns
		25 – 50 MHz	5.00		5.00		5.00		ns
		50 – 100 MHz	3.00		3.00		3.00		ns
		100 – 150 MHz	2.40		2.40		2.40		ns
		150 – 200 MHz	2.00		2.00		2.00		ns
		200 – 250 MHz	1.80		1.80		1.80		ns
		250 – 300 MHz	1.50		1.50		1.50		ns
		300 – 350 MHz	1.30		1.30		1.30		ns
		350 – 400 MHz	1.15		1.15		1.15		ns
> 400 MHz	1.05		1.05		1.05		ns		
Input Clock Cycle-Cycle Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_LF			±300		±300		±300	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_LF			±300		±300		±300	ps
Input Clock Cycle-Cycle Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_CYC_JITT_DLL_HF			±150		±150		±150	ps
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_CYC_JITT_FX_HF			±150		±150		±150	ps
Input Clock Period Jitter (Low Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_LF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_LF			±1		±1		±1	ns
Input Clock Period Jitter (High Frequency Mode)									
CLKIN (using DLL outputs) ⁽¹⁾	CLKIN_PER_JITT_DLL_HF			±1		±1		±1	ns
CLKIN (using CLKFX outputs) ⁽²⁾	CLKIN_PER_JITT_FX_HF			±1		±1		±1	ns
Feedback Clock Path Delay Variation									
CLKFB off-chip feedback	CLKFB_DELAY_VAR_EXT			±1		±1		±1	ns

Notes:

1. “DLL outputs” is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. If both DLL and CLKFX outputs are used, follow the more restrictive specification.
3. If DCM phase shift feature is used and CLKIN frequency > 200 Mhz, CLKIN duty cycle must be within ±5% (45/55 to 55/45).

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L02N_4/D0/DIN ⁽¹⁾	V18		
4	IO_L02P_4/D1	V17		
4	IO_L03N_4/D2/ALT_VRP_4	W18		
4	IO_L03P_4/D3/ALT_VRN_4	Y18		
4	IO_L04N_4/VREF_4	AA18		
4	IO_L04P_4	AB18		
4	IO_L05N_4/VRP_4	W17		
4	IO_L05P_4/VRN_4	Y17		
4	IO_L06N_4	AA17		
4	IO_L06P_4	AB17		
4	IO_L19N_4	V16	NC	NC
4	IO_L19P_4	V15	NC	NC
4	IO_L21N_4	W16	NC	NC
4	IO_L21P_4/VREF_4	Y16	NC	NC
4	IO_L22N_4	AA16	NC	NC
4	IO_L22P_4	AB16	NC	NC
4	IO_L24N_4	W15	NC	NC
4	IO_L24P_4	Y15	NC	NC
4	IO_L49N_4	AA15	NC	
4	IO_L49P_4	AB15	NC	
4	IO_L51N_4	U14	NC	
4	IO_L51P_4/VREF_4	V14	NC	
4	IO_L52N_4	W14	NC	
4	IO_L52P_4	Y14	NC	
4	IO_L54N_4	AA14	NC	
4	IO_L54P_4	AB14	NC	
4	IO_L91N_4/VREF_4	U13		
4	IO_L91P_4	V13		
4	IO_L92N_4	W13		
4	IO_L92P_4	Y13		
4	IO_L93N_4	AA13		
4	IO_L93P_4	AB13		
4	IO_L94N_4/VREF_4	U12		
4	IO_L94P_4	V12		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
4	IO_L95N_4/GCLK3S	W12		
4	IO_L95P_4/GCLK2P	Y12		
4	IO_L96N_4/GCLK1S	AA12		
4	IO_L96P_4/GCLK0P	AB12		
5	IO_L96N_5/GCLK7S	AA11		
5	IO_L96P_5/GCLK6P	Y11		
5	IO_L95N_5/GCLK5S	W11		
5	IO_L95P_5/GCLK4P	V11		
5	IO_L94N_5	U11		
5	IO_L94P_5/VREF_5	U10		
5	IO_L93N_5	AB10		
5	IO_L93P_5	AA10		
5	IO_L92N_5	Y10		
5	IO_L92P_5	W10		
5	IO_L91N_5	V10		
5	IO_L91P_5/VREF_5	V9		
5	IO_L54N_5	AB9	NC	
5	IO_L54P_5	AA9	NC	
5	IO_L52N_5	Y9	NC	
5	IO_L52P_5	W9	NC	
5	IO_L51N_5/VREF_5	AB8	NC	
5	IO_L51P_5	AA8	NC	
5	IO_L49N_5	Y8	NC	
5	IO_L49P_5	W8	NC	
5	IO_L24N_5	U9	NC	NC
5	IO_L24P_5	V8	NC	NC
5	IO_L22N_5	AB7	NC	NC
5	IO_L22P_5	AA7	NC	NC
5	IO_L21N_5/VREF_5	Y7	NC	NC
5	IO_L21P_5	W7	NC	NC
5	IO_L19N_5	AB6	NC	NC
5	IO_L19P_5	AA6	NC	NC
5	IO_L06N_5	Y6		

Table 7: FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
NA	GND	M10		
NA	GND	M9		
NA	GND	L14		
NA	GND	L13		
NA	GND	L12		
NA	GND	L11		
NA	GND	L10		
NA	GND	L9		
NA	GND	K14		
NA	GND	K13		
NA	GND	K12		
NA	GND	K11		
NA	GND	K10		
NA	GND	K9		
NA	GND	J14		
NA	GND	J13		
NA	GND	J12		
NA	GND	J11		
NA	GND	J10		
NA	GND	J9		
NA	GND	D19		
NA	GND	D4		
NA	GND	C20		
NA	GND	C3		
NA	GND	B21		
NA	GND	B2		
NA	GND	A22		
NA	GND	A1		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
2	IO_L45N_2	H23		
2	IO_L45P_2/VREF_2	H24		
2	IO_L46N_2	J21		
2	IO_L46P_2	J20		
2	IO_L48N_2	H25		
2	IO_L48P_2	H26		
2	IO_L49N_2	J22		
2	IO_L49P_2	J23		
2	IO_L51N_2	K21		
2	IO_L51P_2/VREF_2	K22		
2	IO_L52N_2	K20		
2	IO_L52P_2	L20		
2	IO_L54N_2	J24		
2	IO_L54P_2	J25		
2	IO_L67N_2	K23		
2	IO_L67P_2	K24		
2	IO_L69N_2	J26		
2	IO_L69P_2/VREF_2	K26		
2	IO_L70N_2	L22		
2	IO_L70P_2	L21		
2	IO_L72N_2	L25		
2	IO_L72P_2	L26		
2	IO_L73N_2	L19	NC	
2	IO_L73P_2	M19	NC	
2	IO_L75N_2	L23	NC	
2	IO_L75P_2/VREF_2	L24	NC	
2	IO_L76N_2	M22	NC	
2	IO_L76P_2	M21	NC	
2	IO_L78N_2	M23	NC	
2	IO_L78P_2	M24	NC	
2	IO_L91N_2	M25		
2	IO_L91P_2	M26		
2	IO_L93N_2	M20		
2	IO_L93P_2/VREF_2	N20		
2	IO_L94N_2	N22		
2	IO_L94P_2	N21		
2	IO_L96N_2	N24		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
4	IO_L06P_4	Y21		
4	IO_L19N_4	AE24		
4	IO_L19P_4	AF24		
4	IO_L21N_4	AE23		
4	IO_L21P_4/VREF_4	AF23		
4	IO_L22N_4	AE22		
4	IO_L22P_4	AF22		
4	IO_L24N_4	AF21		
4	IO_L24P_4	AF20		
4	IO_L25N_4	AA19	NC	NC
4	IO_L25P_4	AB19	NC	NC
4	IO_L27N_4	AD20	NC	NC
4	IO_L27P_4/VREF_4	AC20	NC	NC
4	IO_L28N_4	AC19	NC	NC
4	IO_L28P_4	AD19	NC	NC
4	IO_L49N_4	AE19		
4	IO_L49P_4	AF19		
4	IO_L51N_4	AA18		
4	IO_L51P_4/VREF_4	AB18		
4	IO_L52N_4	Y18		
4	IO_L52P_4	Y17		
4	IO_L54N_4	AC18		
4	IO_L54P_4	AD18		
4	IO_L67N_4	AE18		
4	IO_L67P_4	AF18		
4	IO_L69N_4	AA17		
4	IO_L69P_4/VREF_4	AB17		
4	IO_L70N_4	AC17		
4	IO_L70P_4	AD17		
4	IO_L72N_4	AF17		
4	IO_L72P_4	AF16		
4	IO_L73N_4	AB16	NC	
4	IO_L73P_4	AC16	NC	
4	IO_L75N_4	AA16	NC	
4	IO_L75P_4/VREF_4	Y16	NC	
4	IO_L76N_4	AD16	NC	
4	IO_L76P_4	AE16	NC	

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
7	IO_L27P_7/VREF_7	H5
7	IO_L27N_7	H6
7	IO_L25P_7	J7
7	IO_L25N_7	J8
7	IO_L24P_7	G1
7	IO_L24N_7	F1
7	IO_L22P_7	G2
7	IO_L22N_7	G3
7	IO_L21P_7/VREF_7	F2
7	IO_L21N_7	F3
7	IO_L19P_7	G5
7	IO_L19N_7	G6
7	IO_L06P_7	F4
7	IO_L06N_7	F5
7	IO_L04P_7	E1
7	IO_L04N_7	E2
7	IO_L03P_7/VREF_7	D1
7	IO_L03N_7	C1
7	IO_L02P_7/VRN_7	E3
7	IO_L02N_7/VRP_7	E4
7	IO_L01P_7	D2
7	IO_L01N_7	D3
0	VCCO_0	K13
0	VCCO_0	K12
0	VCCO_0	K11
0	VCCO_0	J11
0	VCCO_0	J10
0	VCCO_0	G12
0	VCCO_0	D7
0	VCCO_0	C12
1	VCCO_1	K17
1	VCCO_1	K16
1	VCCO_1	K15
1	VCCO_1	J18
1	VCCO_1	J17

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
5	IO_L78P_5	AF16	NC	NC
5	IO_L77N_5	AB16	NC	NC
5	IO_L77P_5	AB17	NC	NC
5	IO_L76N_5	AJ19	NC	NC
5	IO_L76P_5	AJ18	NC	NC
5	IO_L75N_5/VREF_5	AG18	NC	NC
5	IO_L75P_5	AF18	NC	NC
5	IO_L74N_5	AE17	NC	NC
5	IO_L74P_5	AE18	NC	NC
5	IO_L73N_5	AK20	NC	NC
5	IO_L73P_5	AK19	NC	NC
5	IO_L72N_5	AH20	NC	
5	IO_L72P_5	AH19	NC	
5	IO_L71N_5	AD18	NC	
5	IO_L71P_5	AD19	NC	
5	IO_L70N_5	AJ21	NC	
5	IO_L70P_5	AJ20	NC	
5	IO_L69N_5/VREF_5	AG19	NC	
5	IO_L69P_5	AG20	NC	
5	IO_L68N_5	AC18	NC	
5	IO_L68P_5	AC19	NC	
5	IO_L67N_5	AK22	NC	
5	IO_L67P_5	AK21	NC	
5	IO_L54N_5	AF21		
5	IO_L54P_5	AF20		
5	IO_L53N_5	AH22		
5	IO_L53P_5	AH23		
5	IO_L52N_5	AG22		
5	IO_L52P_5	AG21		
5	IO_L51N_5/VREF_5	AF22		
5	IO_L51P_5	AF23		
5	IO_L50N_5	AE19		
5	IO_L50P_5	AE20		
5	IO_L49N_5	AJ23		
5	IO_L49P_5	AJ22		
5	IO_L24N_5	AF24		
5	IO_L24P_5	AG23		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	AC1		
NA	GND	AA28		
NA	GND	AA3		
NA	GND	W26		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	W15		
NA	GND	W14		
NA	GND	W13		
NA	GND	W12		
NA	GND	W5		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	V15		
NA	GND	V14		
NA	GND	V13		
NA	GND	V12		
NA	GND	U24		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U7		
NA	GND	T19		
NA	GND	T18		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L20N_4	AJ10	
4	IO_L20P_4	AJ9	
4	IO_L21N_4	AH9	
4	IO_L21P_4/VREF_4	AH10	
4	IO_L22N_4	AN5	
4	IO_L22P_4	AN4	
4	IO_L23N_4	AE12	
4	IO_L23P_4	AE13	
4	IO_L24N_4	AM9	
4	IO_L24P_4	AL8	
4	IO_L25N_4	AP5	
4	IO_L25P_4	AP4	
4	IO_L26N_4	AG11	
4	IO_L26P_4	AG12	
4	IO_L27N_4	AN7	
4	IO_L27P_4/VREF_4	AN6	
4	IO_L28N_4	AL10	
4	IO_L28P_4	AL9	
4	IO_L29N_4	AF12	
4	IO_L29P_4	AF13	
4	IO_L30N_4	AK10	
4	IO_L30P_4	AK11	
4	IO_L49N_4	AP7	
4	IO_L49P_4	AP6	
4	IO_L50N_4	AH13	
4	IO_L50P_4	AH12	
4	IO_L51N_4	AJ11	
4	IO_L51P_4/VREF_4	AJ12	
4	IO_L52N_4	AP9	
4	IO_L52P_4	AN8	
4	IO_L53N_4	AG13	
4	IO_L53P_4	AG14	
4	IO_L54N_4	AM11	
4	IO_L54P_4	AL11	
4	IO_L60N_4	AN10	NC
4	IO_L60P_4	AN9	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L71P_6	AD34	
6	IO_L71N_6	AC34	
6	IO_L72P_6	AC31	
6	IO_L72N_6	AD31	
6	IO_L73P_6	Y27	
6	IO_L73N_6	W27	
6	IO_L74P_6	AB29	
6	IO_L74N_6	AA29	
6	IO_L75P_6	AB31	
6	IO_L75N_6/VREF_6	AA31	
6	IO_L76P_6	Y28	
6	IO_L76N_6	Y29	
6	IO_L77P_6	AB33	
6	IO_L77N_6	AA33	
6	IO_L78P_6	AA30	
6	IO_L78N_6	AB30	
6	IO_L79P_6	W24	NC
6	IO_L79N_6	V24	NC
6	IO_L80P_6	AB34	NC
6	IO_L80N_6	AA34	NC
6	IO_L81P_6	W33	NC
6	IO_L81N_6/VREF_6	Y34	NC
6	IO_L82P_6	W25	NC
6	IO_L82N_6	V25	NC
6	IO_L83P_6	Y32	NC
6	IO_L83N_6	AA32	NC
6	IO_L84P_6	W29	NC
6	IO_L84N_6	V29	NC
6	IO_L91P_6	W28	
6	IO_L91N_6	V28	
6	IO_L92P_6	V33	
6	IO_L92N_6	V34	
6	IO_L93P_6	Y31	
6	IO_L93N_6/VREF_6	W31	
6	IO_L94P_6	V26	
6	IO_L94N_6	V27	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	VCCO_7	K34	
7	VCCO_7	G31	
NA	CCLK	AH8	
NA	PROG_B	D30	
NA	DONE	AJ7	
NA	M0	AH27	
NA	M1	AJ28	
NA	M2	AK29	
NA	HSWAP_EN	E29	
NA	TCK	F7	
NA	TDI	C31	
NA	TDO	D5	
NA	TMS	E6	
NA	PWRDWN_B	AK6	
NA	DXN	F28	
NA	DXP	G27	
NA	VBATT	C4	
NA	RSVD	G8	
NA	VCCAUX	AM30	
NA	VCCAUX	AM18	
NA	VCCAUX	AM5	
NA	VCCAUX	V3	
NA	VCCAUX	U32	
NA	VCCAUX	C30	
NA	VCCAUX	C17	
NA	VCCAUX	C5	
NA	VCCINT	AD24	
NA	VCCINT	AD11	
NA	VCCINT	AC23	
NA	VCCINT	AC12	
NA	VCCINT	AB22	
NA	VCCINT	AB21	
NA	VCCINT	AB20	
NA	VCCINT	AB19	
NA	VCCINT	AB18	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	AP33	
NA	GND	AP32	
NA	GND	AP27	
NA	GND	AP8	
NA	GND	AP3	
NA	GND	AP2	
NA	GND	AN34	
NA	GND	AN33	
NA	GND	AN20	
NA	GND	AN15	
NA	GND	AN2	
NA	GND	AN1	
NA	GND	AM34	
NA	GND	AM32	
NA	GND	AM25	
NA	GND	AM10	
NA	GND	AM3	
NA	GND	AM1	
NA	GND	AL31	
NA	GND	AL4	
NA	GND	AK30	
NA	GND	AK23	
NA	GND	AK12	
NA	GND	AK5	
NA	GND	AJ29	
NA	GND	AJ6	
NA	GND	AH28	
NA	GND	AH21	
NA	GND	AH14	
NA	GND	AH7	
NA	GND	AG34	
NA	GND	AG27	
NA	GND	AG8	
NA	GND	AG1	
NA	GND	AF19	
NA	GND	AF16	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L01N_5/RDWR_B	AU36		
5	IO_L01P_5/CS_B	AV36		
6	IO_L01P_6	AJ27		
6	IO_L01N_6	AH27		
6	IO_L02P_6/VRN_6	AT38		
6	IO_L02N_6/VRP_6	AR37		
6	IO_L03P_6	AP36		
6	IO_L03N_6/VREF_6	AR36		
6	IO_L04P_6	AJ28		
6	IO_L04N_6	AH29		
6	IO_L05P_6	AT39		
6	IO_L05N_6	AR39		
6	IO_L06P_6	AN34		
6	IO_L06N_6	AP35		
6	IO_L07P_6	AH28	NC	
6	IO_L07N_6	AG28	NC	
6	IO_L08P_6	AR38	NC	
6	IO_L08N_6	AP38	NC	
6	IO_L09P_6	AM34	NC	
6	IO_L09N_6/VREF_6	AM33	NC	
6	IO_L10P_6	AL32	NC	
6	IO_L10N_6	AK32	NC	
6	IO_L11P_6	AP37	NC	
6	IO_L11N_6	AN37	NC	
6	IO_L12P_6	AM35	NC	
6	IO_L12N_6	AN35	NC	
6	IO_L19P_6	AK31		
6	IO_L19N_6	AJ30		
6	IO_L20P_6	AP39		
6	IO_L20N_6	AN39		
6	IO_L21P_6	AK33		
6	IO_L21N_6/VREF_6	AL33		
6	IO_L22P_6	AJ31		
6	IO_L22N_6	AH31		
6	IO_L23P_6	AN38		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
NA	VCCINT	T21	
NA	VCCINT	U10	
NA	VCCINT	U13	
NA	VCCINT	U19	
NA	VCCINT	U22	
NA	VCCINT	V13	
NA	VCCINT	V19	
NA	VCCINT	W13	
NA	VCCINT	W14	
NA	VCCINT	W15	
NA	VCCINT	W16	
NA	VCCINT	W17	
NA	VCCINT	W18	
NA	VCCINT	W19	
NA	VCCINT	Y12	
NA	VCCINT	Y16	
NA	VCCINT	Y20	
NA	VCCINT	AA11	
NA	VCCINT	AA16	
NA	VCCINT	AA21	
NA	VCCINT	AB15	
NA	VCCINT	AB17	
NA	GND	A2	
NA	GND	A3	
NA	GND	A16	
NA	GND	A29	
NA	GND	A30	
NA	GND	B1	
NA	GND	B2	
NA	GND	B8	
NA	GND	B24	
NA	GND	B30	
NA	GND	B31	
NA	GND	C1	
NA	GND	C3	
NA	GND	C29	
NA	GND	C31	
NA	GND	D4	